

## Inverter Grade Thyristors (Hockey PUK Version), 330 A



TO-200AB (A-PUK)

### FEATURES

- Metal case with ceramic insulator
- All diffused design
- Center amplifying gate
- Guaranteed high  $dV/dt$
- International standard case TO-200AB (A-PUK)
- Guaranteed high  $dI/dt$
- High surge current capability
- Low thermal impedance
- High speed performance
- Material categorization: For definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT

### PRODUCT SUMMARY

|                    |                  |
|--------------------|------------------|
| Package            | TO-200AB (A-PUK) |
| Diode variation    | Single SCR       |
| $I_{T(AV)}$        | 330 A            |
| $V_{DRM}/V_{RRM}$  | 1000 V, 1200 V   |
| $V_{TM}$           | 2.07 V           |
| $I_{TSM}$ at 50 Hz | 4680 A           |
| $I_{TSM}$ at 60 Hz | 4900 A           |
| $I_{GT}$           | 200 mA           |
| $T_C/T_{hs}$       | 55 °C            |

### TYPICAL APPLICATIONS

- Inverters
- Choppers
- Induction heating
- All types of force-commutated converters

### MAJOR RATINGS AND CHARACTERISTICS

| PARAMETER         | TEST CONDITIONS | VALUES       | UNITS             |
|-------------------|-----------------|--------------|-------------------|
| $I_{T(AV)}$       |                 | 330          | A                 |
|                   | $T_{hs}$        | 55           | °C                |
| $I_{T(RMS)}$      |                 | 610          | A                 |
|                   | $T_{hs}$        | 25           | °C                |
| $I_{TSM}$         | 50 Hz           | 4680         | A                 |
|                   | 60 Hz           | 4900         |                   |
| $i^2t$            | 50 Hz           | 110          | kA <sup>2</sup> s |
|                   | 60 Hz           | 100          |                   |
| $V_{DRM}/V_{RRM}$ |                 | 1000 to 1200 | V                 |
| $t_q$             | Range           | 15 to 30     | μs                |
| $T_J$             |                 | -40 to 125   | °C                |

### ELECTRICAL SPECIFICATIONS

#### VOLTAGE RATINGS

| TYPE NUMBER  | VOLTAGE CODE | $V_{DRM}/V_{RRM}$ , MAXIMUM REPETITIVE PEAK VOLTAGE<br>V | $V_{RSM}$ , MAXIMUM NON-REPETITIVE PEAK VOLTAGE<br>V | $I_{DRM}/I_{RRM}$ MAXIMUM AT $T_J = T_J$ MAXIMUM<br>mA |
|--------------|--------------|--|--|--|
| VS-ST173C..C | 10           | 1000   | 1100   | 40   |
|              | 12           | 1200   | 1300   |  |



| CURRENT CARRYING CAPABILITY      |           |     |           |      |           |      |       |
|----------------------------------|-----------|-----|-----------|------|-----------|------|-------|
| FREQUENCY                        |           |     |           |      |           |      | UNITS |
| 50 Hz                            | 760       | 660 | 1200      | 1030 | 5570      | 4920 | A     |
| 400 Hz                           | 730       | 590 | 1260      | 1080 | 2800      | 2460 |       |
| 1000 Hz                          | 600       | 490 | 1200      | 1030 | 1620      | 1390 |       |
| 2500 Hz                          | 350       | 270 | 850       | 720  | 800       | 680  |       |
| Recovery voltage $V_r$           | 50        |     | 50        |      | 50        |      | V     |
| Voltage before turn-on $V_d$     | $V_{DRM}$ |     | $V_{DRM}$ |      | $V_{DRM}$ |      |       |
| Rise of on-state current $di/dt$ | 50        |     | -         |      | -         |      | A/μs  |
| Heatsink temperature             | 40        | 55  | 40        | 55   | 40        | 55   | °C    |
| Equivalent values for RC circuit | 47/0.22   |     | 47/0.22   |      | 47/0.22   |      | Ω/μF  |

| ON-STATE CONDUCTION  |               |   |                           |   |           |                    |
|--|---------------|---|---------------------------|---|-----------|--------------------|
| PARAMETER  | SYMBOL        | TEST CONDITIONS   |                           |   | VALUES    | UNITS              |
| Maximum average on-state current at heatsink temperature   | $I_{T(AV)}$   | 180° conduction, half sine wave double side (single side) cooled                        |                           |   | 330 (120) | A                  |
|  |               |   |                           |   | 55 (85)   | °C                 |
| Maximum RMS on-state current                               | $I_{T(RMS)}$  | DC at 25 °C heatsink temperature double side cooled                                     |                           |   | 610       | A                  |
| Maximum peak, one half cycle, non-repetitive surge current | $I_{TSM}$     | t = 10 ms   | No voltage reapplied      | Sinusoidal half wave, initial $T_J = T_J$ maximum | 4680      |                    |
|  |               | t = 8.3 ms  |                           |   | 4900      |                    |
|  |               | t = 10 ms   | 100 % $V_{RRM}$ reapplied |   | 3940      |                    |
|  |               | t = 8.3 ms  |                           |   | 4120      |                    |
| Maximum $I^2t$ for fusing                                  | $I^2t$        | t = 10 ms   | No voltage reapplied      |   | 110       |                    |
|  |               | t = 8.3 ms  |                           |   | 100       |                    |
|  |               | t = 10 ms   | 100 % $V_{RRM}$ reapplied |   | 77        |                    |
|  |               | t = 8.3 ms  |                           |   | 71        |                    |
| Maximum $I^2\sqrt{t}$ for fusing                           | $I^2\sqrt{t}$ | t = 0.1 to 10 ms, no voltage reapplied  |                           |   | 1100      | kA <sup>2</sup> √s |
| Maximum peak on-state voltage                              | $V_{TM}$      | $I_{TM} = 600$ A, $T_J = T_J$ maximum, $t_p = 10$ ms sine wave pulse                    |                           |   | 2.07      | V                  |
| Low level value of threshold voltage                       | $V_{T(TO)1}$  | $(16.7\% \times \pi \times I_{T(AV)}) < I < \pi \times I_{T(AV)}$ , $T_J = T_J$ maximum |                           |   | 1.55      |                    |
| High level value of threshold voltage                      | $V_{T(TO)2}$  | $I > \pi \times I_{T(AV)}$ , $T_J = T_J$ maximum  |                           |   | 1.61      |                    |
| Low level value of forward slope resistance                | $r_{t1}$      | $(16.7\% \times \pi \times I_{T(AV)}) < I < \pi \times I_{T(AV)}$ , $T_J = T_J$ maximum |                           |   | 0.87      | mΩ                 |
| High level value of forward slope resistance               | $r_{t2}$      | $I > \pi \times I_{T(AV)}$ , $T_J = T_J$ maximum  |                           |   | 0.77      |                    |
| Maximum holding current                                    | $I_H$         | $T_J = 25$ °C, $I_T > 30$ A   |                           |   | 600       | mA                 |
| Typical latching current                                   | $I_L$         | $T_J = 25$ °C, $V_A = 12$ V, $R_a = 6$ Ω, $I_G = 1$ A                                   |                           |   | 1000      |                    |

| SWITCHING  |         |   |  |  |        |       |
|--|---------|---|--|--|--------|-------|
| PARAMETER  | SYMBOL  | TEST CONDITIONS   |  |  | VALUES | UNITS |
| Maximum non-repetitive rate of rise of turned on current | $di/dt$ | $T_J = T_J$ maximum, $V_{DRM} = \text{Rated } V_{DRM}$ , $I_{TM} = 2 \times di/dt$  |  |  | 1000   | A/μs  |
| Typical delay time                                       | $t_d$   | $T_J = 25$ °C, $V_{DM} = \text{Rated } V_{DRM}$ , $I_{TM} = 50$ A DC, $t_p = 1$ μs Resistive load, gate pulse: 10 V, 5 Ω source       |  |  | 1.1    | μs    |
| Maximum turn-off time                                    | minimum | $T_J = T_J$ maximum, $I_{TM} = 300$ A, commutating $di/dt = 20$ A/μs $V_R = 50$ V, $t_p = 500$ μs, $dV/dt$ : See table in device code |  |  | 15     |       |
|  | maximum |   |  |  | $t_q$  |       |



| <b>BLOCKING</b>                                    |                                     |  |        |       |
|--|-------------------------------------|--|--------|-------|
| PARAMETER  | SYMBOL                              | TEST CONDITIONS  | VALUES | UNITS |
| Maximum critical rate of rise of off-state voltage | dV/dt                               | T <sub>J</sub> = T <sub>J</sub> maximum, linear to 80 % V <sub>DRM</sub> , higher value available on request | 500    | V/μs  |
| Maximum peak reverse and off-state leakage current | I <sub>RRM</sub> , I <sub>DRM</sub> | T <sub>J</sub> = T <sub>J</sub> maximum, rated V <sub>DRM</sub> /V <sub>RRM</sub> applied                    | 40     | mA    |

| <b>TRIGGERING</b>                           |                    |   |        |       |
|---|--------------------|---|--------|-------|
| PARAMETER                                   | SYMBOL             | TEST CONDITIONS   | VALUES | UNITS |
| Maximum peak gate power                     | P <sub>GM</sub>    | T <sub>J</sub> = T <sub>J</sub> maximum, f = 50 Hz, d% = 50             | 60     | W     |
| Maximum average gate power                  | P <sub>G(AV)</sub> |   | 10     |       |
| Maximum peak positive gate current          | I <sub>GM</sub>    | T <sub>J</sub> = T <sub>J</sub> maximum, t <sub>p</sub> ≤ 5 ms          | 10     | A     |
| Maximum peak positive gate voltage          | + V <sub>GM</sub>  |   | 20     | V     |
| Maximum peak negative gate voltage          | - V <sub>GM</sub>  |   | 5      |       |
| Maximum DC gate current required to trigger | I <sub>GT</sub>    | T <sub>J</sub> = 25 °C, V <sub>A</sub> = 12 V, R <sub>a</sub> = 6 Ω     | 200    | mA    |
| Maximum DC gate voltage required to trigger | V <sub>GT</sub>    |   | 3      | V     |
| Maximum DC gate current not to trigger      | I <sub>GD</sub>    | T <sub>J</sub> = T <sub>J</sub> maximum, rated V <sub>DRM</sub> applied | 20     | mA    |
| Maximum DC gate voltage not to trigger      | V <sub>GD</sub>    |   | 0.25   | V     |

| <b>THERMAL AND MECHANICAL SPECIFICATIONS</b>     |                     |   |                  |        |
|--|---------------------|---|------------------|--------|
| PARAMETER  | SYMBOL              | TEST CONDITIONS                               | VALUES           | UNITS  |
| Maximum operating junction temperature range     | T <sub>J</sub>      |   | - 40 to 125      | °C     |
| Maximum storage temperature range                | T <sub>Stg</sub>    |   | - 40 to 150      |        |
| Maximum thermal resistance, junction to heatsink | R <sub>thJ-hs</sub> | DC operation single side cooled               | 0.17             | K/W    |
|  |                     | DC operation double side cooled               | 0.08             |        |
| Maximum thermal resistance, case to heatsink     | R <sub>thC-hs</sub> | DC operation single side cooled               | 0.033            |        |
|  |                     | DC operation double side cooled               | 0.017            |        |
| Mounting force, ± 10 %                           |                     |   | 4900 (500)       | N (kg) |
| Approximate weight                               |                     |   | 50               | g      |
| Case style                                       |                     | See dimensions - link at the end of datasheet | TO-200AB (A-PUK) |        |

| <b>ΔR<sub>thJ-hs</sub> CONDUCTION</b> |                       |             |                        |             |   |       |
|---------------------------------------|-----------------------|-------------|------------------------|-------------|---|-------|
| CONDUCTION ANGLE                      | SINUSOIDAL CONDUCTION |             | RECTANGULAR CONDUCTION |             | TEST CONDITIONS                         | UNITS |
|                                       | Single Side           | Double Side | Single Side            | Double Side |   |       |
| 180°                                  | 0.015                 | 0.016       | 0.011                  | 0.011       | T <sub>J</sub> = T <sub>J</sub> maximum | K/W   |
| 120°                                  | 0.018                 | 0.019       | 0.019                  | 0.019       |   |       |
| 90°                                   | 0.024                 | 0.024       | 0.026                  | 0.026       |   |       |
| 60°                                   | 0.035                 | 0.035       | 0.036                  | 0.037       |   |       |
| 30°                                   | 0.060                 | 0.060       | 0.060                  | 0.061       |   |       |

**Note**

- The table above shows the increment of thermal resistance R<sub>thJ-hs</sub> when devices operate at different conduction angles than DC

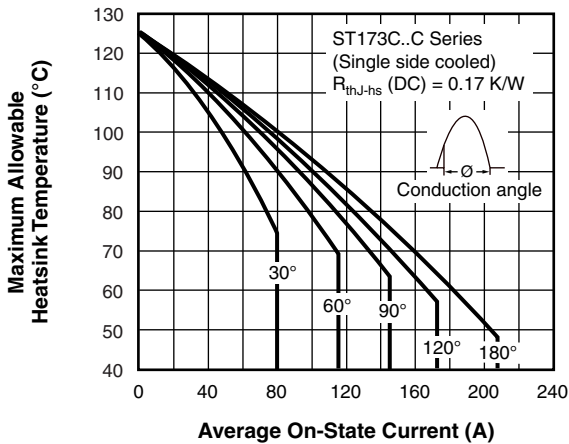


Fig. 1 - Current Ratings Characteristics

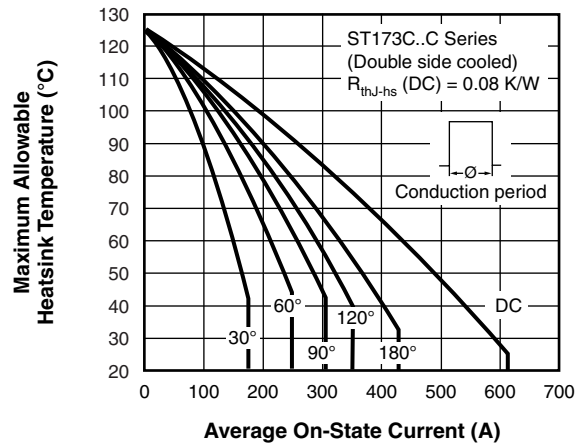


Fig. 4 - Current Ratings Characteristics

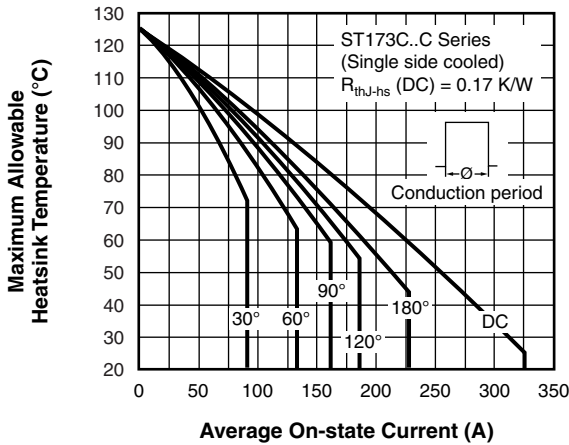


Fig. 2 - Current Ratings Characteristics

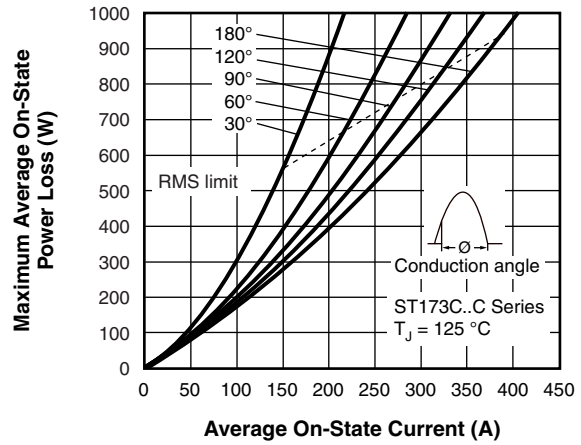


Fig. 5 - On-State Power Loss Characteristics

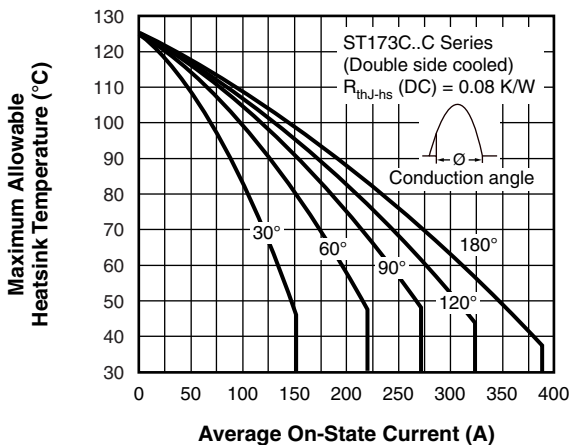


Fig. 3 - Current Ratings Characteristics

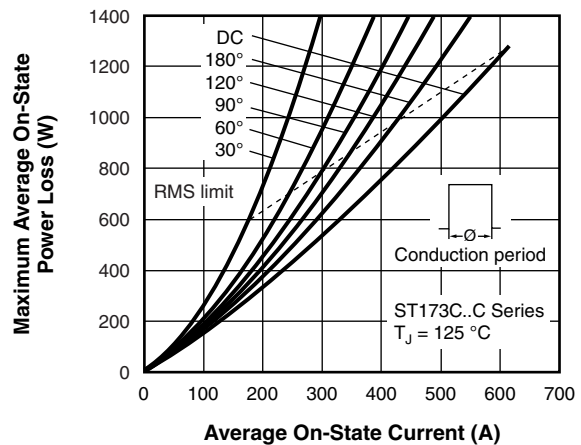


Fig. 6 - On-State Power Loss Characteristics

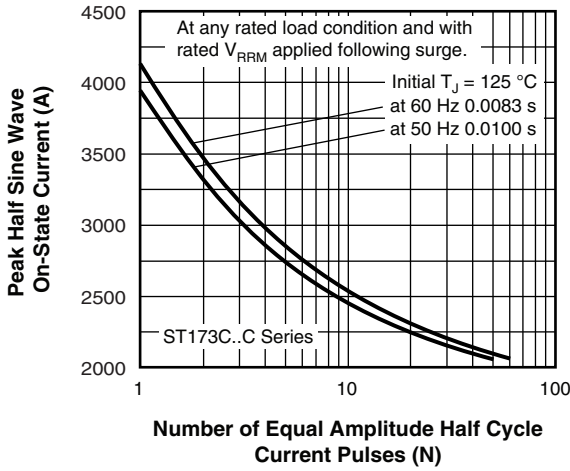


Fig. 7 - Maximum Non-Repetitive Surge Current Single and Double Side Cooled

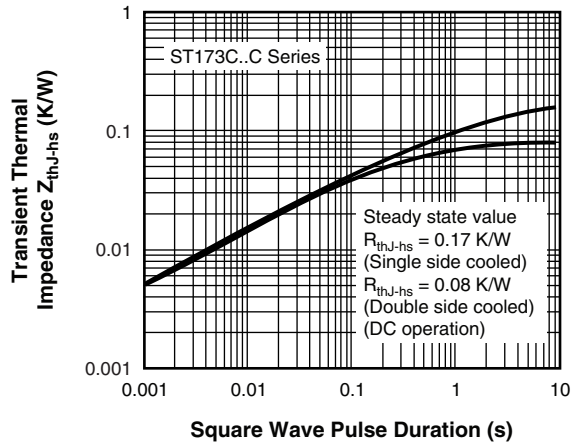


Fig. 10 - Thermal Impedance  $Z_{thJ-hs}$  Characteristics

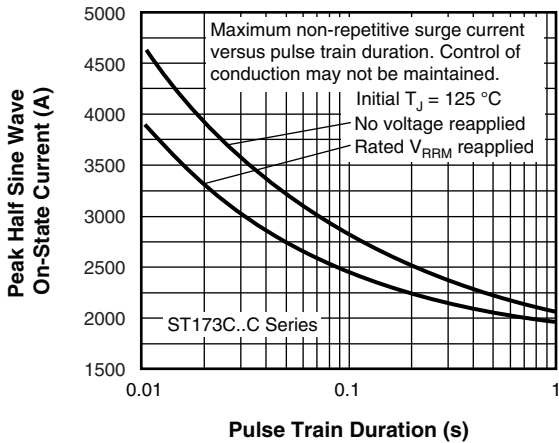


Fig. 8 - Maximum Non-Repetitive Surge Current Single and Double Side Cooled

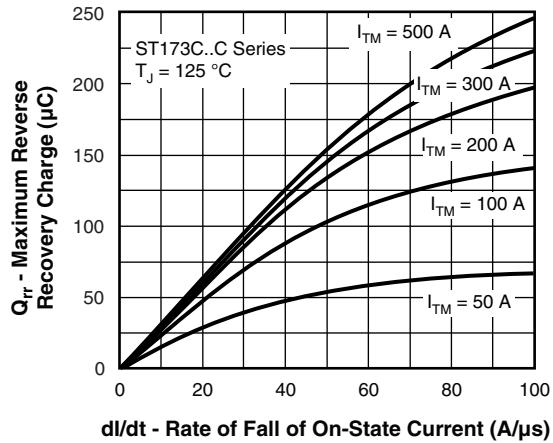


Fig. 11 - Reverse Recovered Charge Characteristics

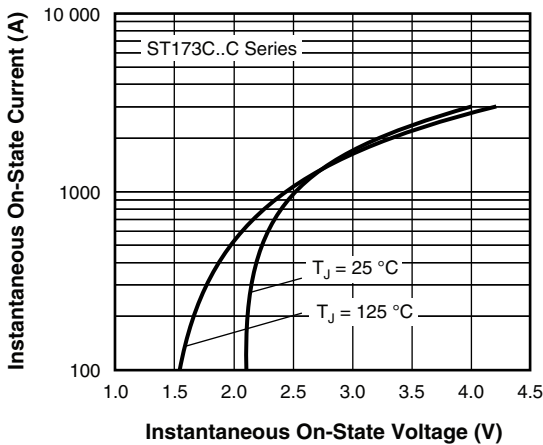


Fig. 9 - On-State Voltage Drop Characteristics

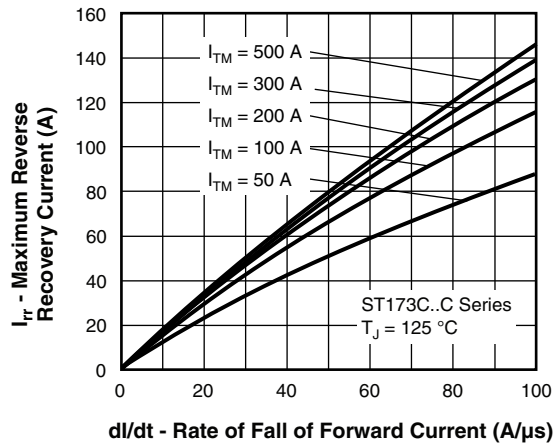


Fig. 12 - Reverse Recovered Current Characteristics

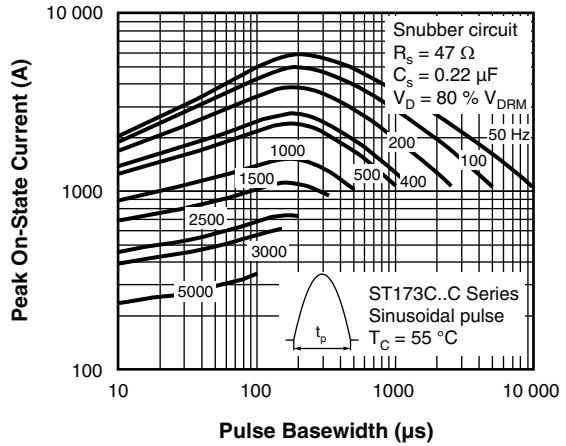
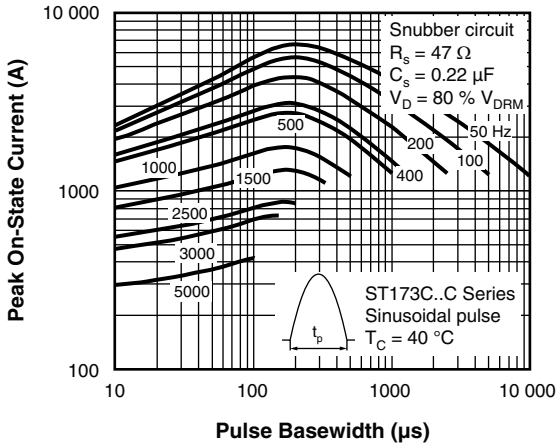


Fig. 13 - Frequency Characteristics

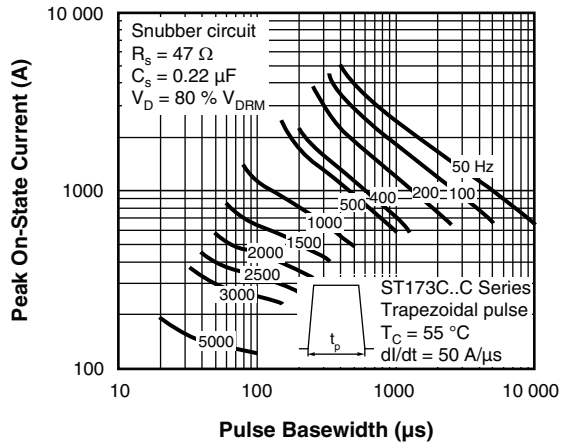
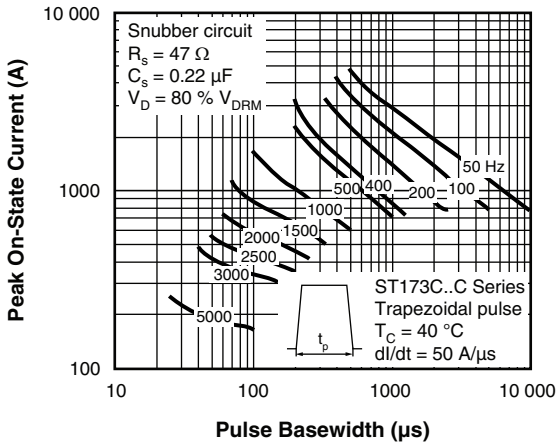


Fig. 14 - Frequency Characteristics

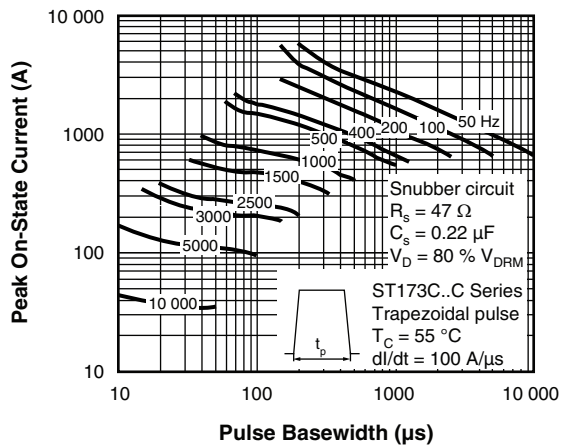
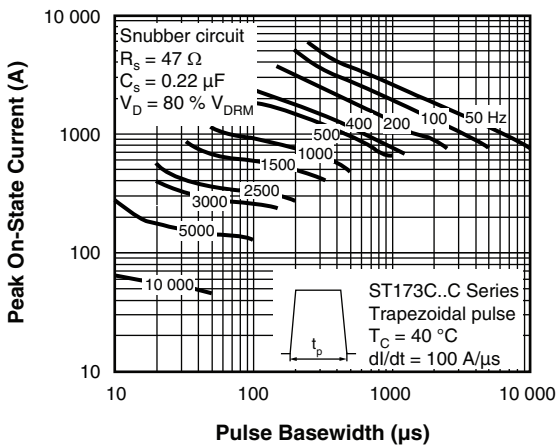


Fig. 15 - Frequency Characteristics

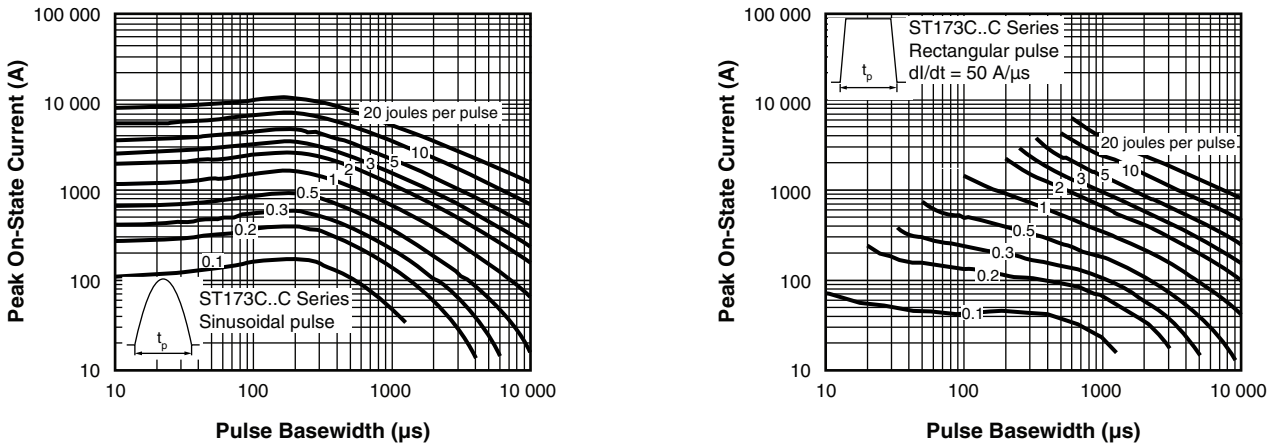


Fig. 16 - Maximum On-State Energy Power Loss Characteristics

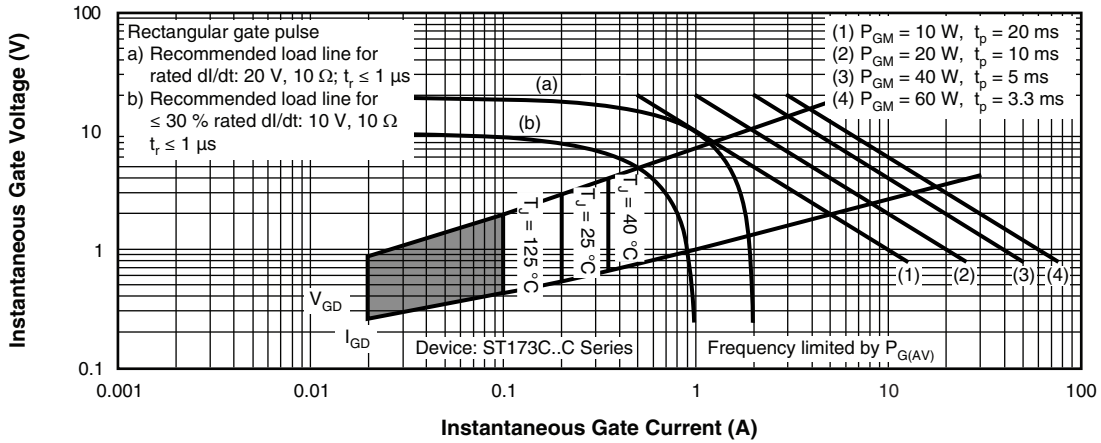
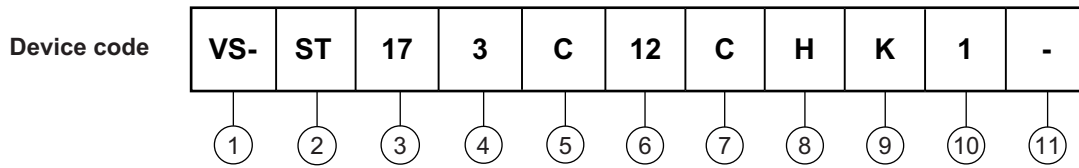


Fig. 17 - Gate Characteristics



## ORDERING INFORMATION TABLE



- 1** - Vishay Semiconductors product
- 2** - Thyristor
- 3** - Essential part number
- 4** - 3 = Fast turn-off
- 5** - C = Ceramic PUK
- 6** - Voltage code x 100 =  $V_{RRM}$  (see Voltage Ratings table)
- 7** - C = PUK case TO-200AB (A-PUK)
- 8** - Reapplied dV/dt code (for  $t_q$  test condition)
- 9** -  $t_q$  code
- 10** - 0 = Eyelet terminals  
(gate and aux. cathode unsoldered leads)  
1 = Fast-on terminals  
(gate and aux. cathode unsoldered leads)  
2 = Eyelet terminals  
(gate and aux. cathode soldered leads)  
3 = Fast-on terminals  
(gate and aux. cathode soldered leads)
- 11** - Critical dV/dt:
  - None = 500 V/ $\mu$ s (standard value)
  - L = 1000 V/ $\mu$ s (special selection)

| dV/dt - $t_q$ combinations available |    |    |     |     |             |
|--------------------------------------|----|----|-----|-----|-------------|
| dV/dt (V/ $\mu$ s)                   | 20 | 50 | 100 | 200 | 400         |
| $t_q$ ( $\mu$ s)                     | 15 | CL | --  | --  | --          |
|                                      | 18 | CP | DP  | EP  | <b>FP</b> * |
|                                      | 20 | CK | DK  | EK  | <b>FK</b> * |
|                                      | 25 | CJ | DJ  | EJ  | FJ          |
|                                      | 30 | -- | DH  | EH  | FH          |

\* Standard part number.  
All other types available only on request.

| LINKS TO RELATED DOCUMENTS |  |
|----------------------------|--|
| Dimensions                 | <a href="http://www.vishay.com/doc?95074">www.vishay.com/doc?95074</a> |



## TO-200AB (A-PUK)

### DIMENSIONS in millimeters (inches)

Anode to gate  
 Creepage distance: 7.62 (0.30) minimum  
 Strike distance: 7.12 (0.28) minimum



Quote between upper and lower pole pieces has to be considered after application of mounting force (see thermal and mechanical specification)



## Disclaimer

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